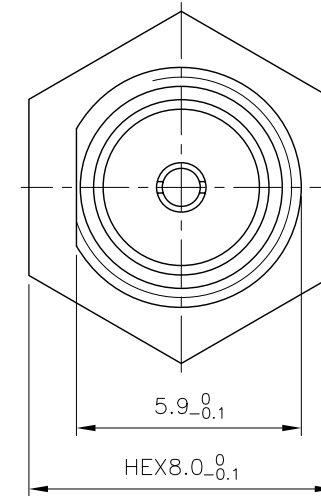
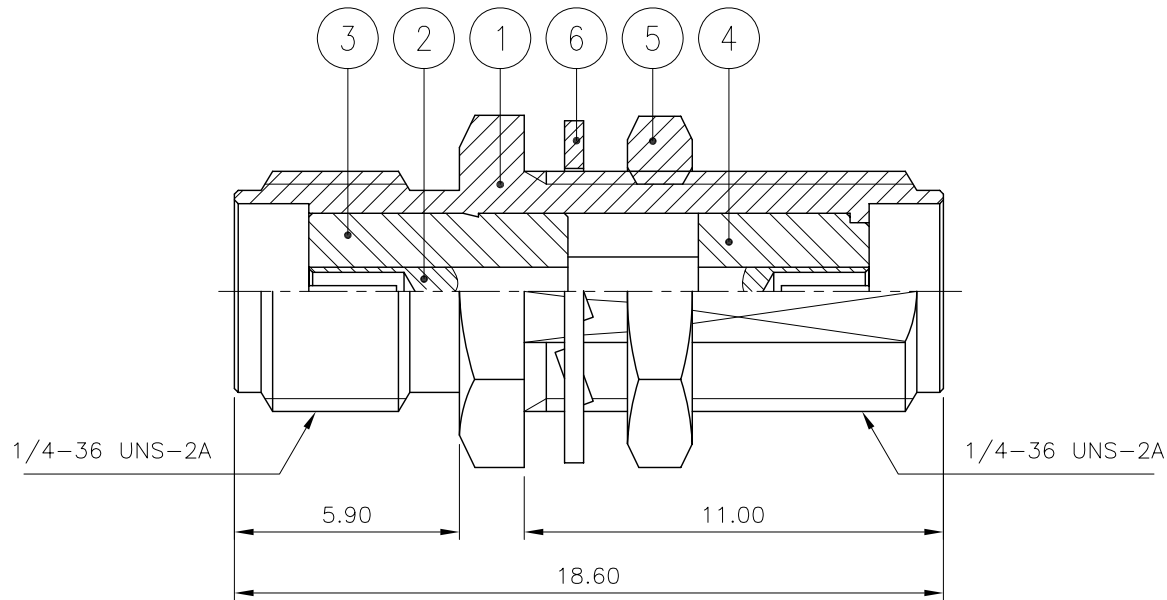


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration			2005.11.03.	
1	[설번No.201403-0004] 조립성 향상(BODY 내경부 뉴시턱 추가 및 INSULATOR 구성 변경)	M.H.SONG	I.C.KIM	2014.03.17.	



6	WASHER	1	BsS	Gold Plate	DWA00005-N/1
5	NUT	1	MBsBD	Gold Plate	DNT00024-5/1
4	INSULATOR	1	TEFLON		DIN00216-N/1
3	INSULATOR	1	TEFLON		DIN00126-N/2 DIN00126-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT00079-5/1
1	BODY	1	MBsBD	Gold Plate	DBD00115-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 03. 17.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	E.H.KIM	KJ COMTECH CO.,LTD. TITLE SMA50 (J) SMA50 (J) BH
		DRAWN BY	M.H.SONG	
FINISH		SCALE	UNIT	A4 DWG NO. AD00287-7/1 REVISION 1 SHEET 1 of 1
		5/1	mm	